

Research collaborations

International collaborations

LESIM has established outstanding international collaborations for ongoing research activities. Collaboration with the Microelectronic Laboratory of the University of Bordeaux aims at the development of an instrument prototype to measure thin thickness by means of ultrasound. Models and methods for ADC and DAC characterization are being carried out in collaboration with the Physikalisch-Technische Bundesanstalt in Berlin, the Microelectronic Laboratory of the University of Westminster in London, the Telecommunication Department of the Technical University of Kosice (SK).

New methods for the automatic detection and classification of transients are the topic that the collaboration held with the Department of Electrical and Computer Engineering of the University of Oporto is based on.

Bilateral agreements have been activated for ERASMUS program with details being available at the [ERASMUS office](#) .